



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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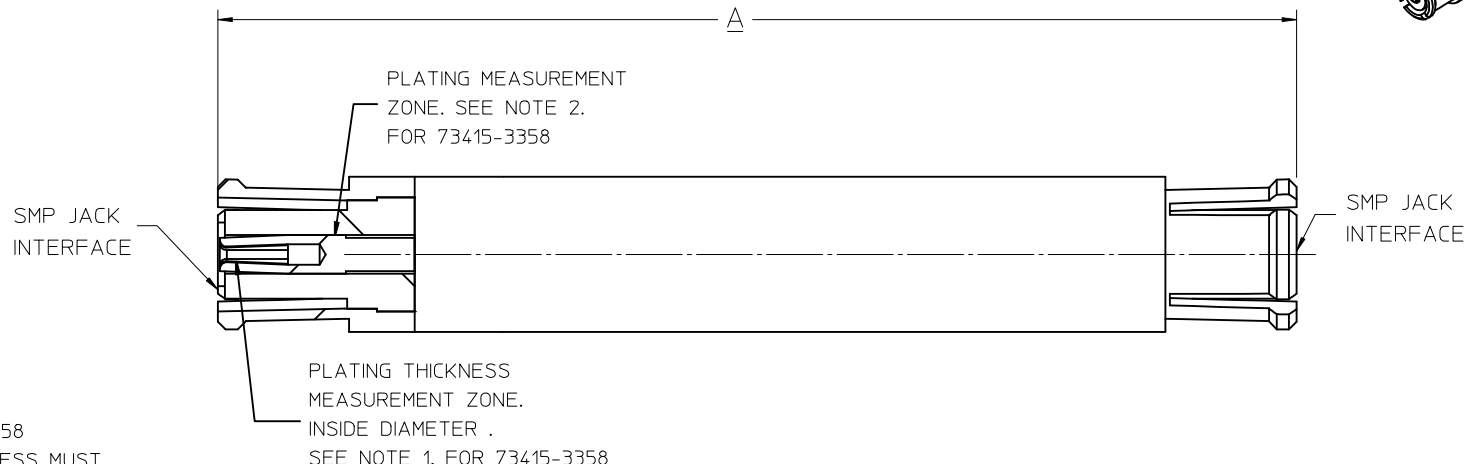
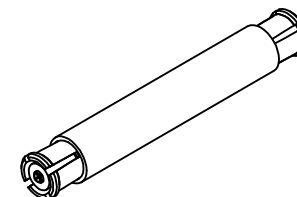


MATERIALS AND FINISHES:

BODY BERYLLIUM COPPER
PLATED GOLD

CONTACT BERYLLIUM COPPER
PLATED GOLD

INSULATOR TEFLON



NOTE 1: FOR 73415-3358
GOLD PLATING THICKNESS MUST BE 10 MICROINCHES MINIMUM AT STATED LOCATION.

NOTE 2: FOR 73415-3358
GOLD PLATING THICKNESS MUST BE 30 MICROINCHES MINIMUM AT STATED LOCATION.

73415-3356	PLACE 73415-3351 INTO SMALL TRAY
73415-3355	PLACE 73415-3350 INTO SMALL TRAY
PART NO.	DESCRIPTION

73415-3359	.646 REF	16.40 REF
73415-3358	.677 REF	17.20 REF
73415-3357	.449 REF	11.40 REF
73415-3354	1.131 REF	28.73 REF
73415-3353	.571 REF	14.50 REF
73415-3352	.520 REF	13.21 REF
73415-3351	.799 REF	20.30 REF
73415-3350	.937 REF	23.80 REF
PART NO.	IN	MM

PS-89675-3320	PRODUCT SPECIFICATION
MIL-STD-348A, FIG. 326.1	INTERFACE
SPECIFICATION	DESCRIPTION

CHG: ADDED NOTE 1 & NOTE 2
 EC NO: URF2009-0237
 DRW: CL I
 CHKD: 2008/11/11
 APPR: MHUANG 2008/11/11

DESCRIPTION
 D1

QUALITY SYMBOLS
 ▽=0
 ▽=0

GENERAL TOLERANCES (UNLESS SPECIFIED)

	mm	INCH
4 PLACES	± .005	± .0004
3 PLACES	± .005	± .0004
2 PLACES	± .005	± .0004
1 PLACE	± .005	± .0004

ANGULAR ± 2 °

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

DIMENSION STYLE: MM/IN

DRAWN BY: TEF
 DATE: 2001/05/22

CHECKED BY: SSS
 DATE: 2001/05/22

APPROVED BY: GMH
 DATE: 2001/05/22

MATERIAL NO.: SEE TABLE

SIZE: C

SCALE: METRIC

DESIGN UNITS: METRIC

THIRD ANGLE PROJECTION

TITLE: SMP JACK TO JACK ADAPTER
50 OHMS SMP-J/J/ADP

MOLEX INCORPORATED

DOCUMENT NO.: SD-73415-335

SHEET NO.: 1 OF 1

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